

GR 00 P 1583



1762

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By: M. P.

Date: 6/6/02

#13/B
Midea
7/3/02

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicant : Klaus Lowack et al.

Applic. No. : 09/817,963

Filed : March 27, 2001

Title : Method For The Metalization Of An Insulator
And/Or A Dielectric

Examiner : Brian K. Talbot

Group Art Unit : 1762

A M E N D M E N T

Hon. Commissioner of Patents and Trademarks,
Washington, D. C. 20231

Sir :

Responsive to the Office action dated March 8, 2002 kindly
amend the above-identified application as follows:

In the Specification:

On page 3, lines 18-21, replace the paragraph with:

-- The object and subject of the invention are achieved by a
process for the metallization of at least one insulating layer

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